

# 2SC3932G

## Silicon NPN epitaxial planar type

For high-frequency amplification/oscillation/mixing

### ■ Features

- High transition frequency  $f_T$
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing

### ■ Package

- Code  
SMini3-F2
- Marking Symbol: R
- Pin Name
  1. Base
  2. Emitter
  3. Collector

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	30	V
Collector-emitter voltage (Base open)	$V_{CEO}$	20	V
Emitter-base voltage (Collector open)	$V_{EBO}$	3	V
Collector current	$I_C$	50	mA
Collector power dissipation	$P_C$	150	mW
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

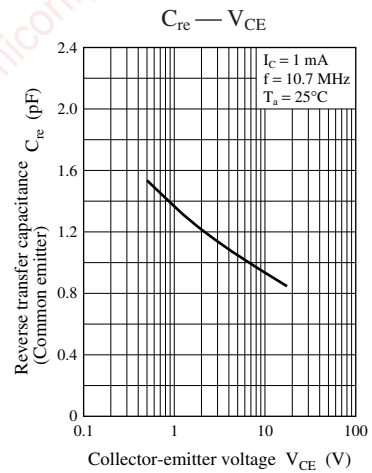
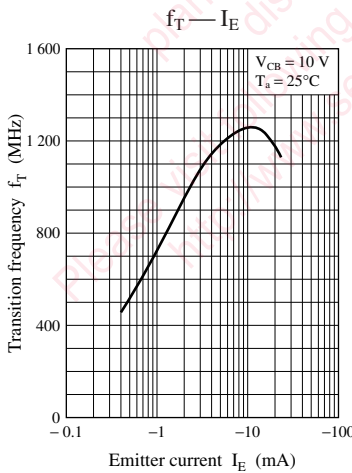
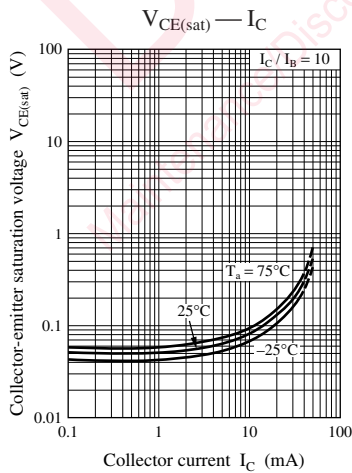
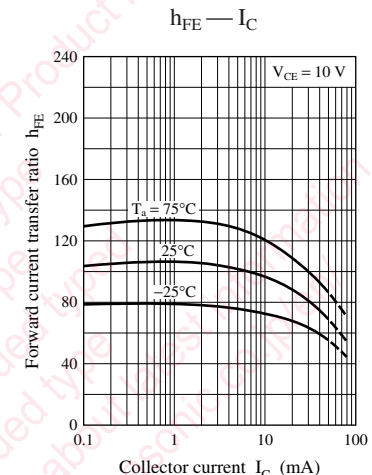
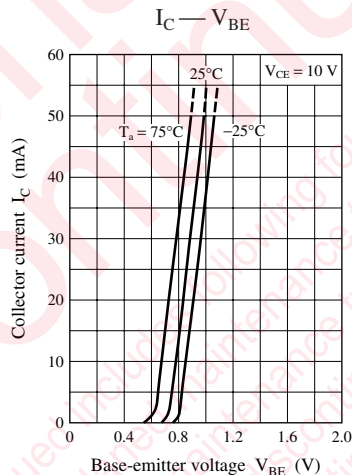
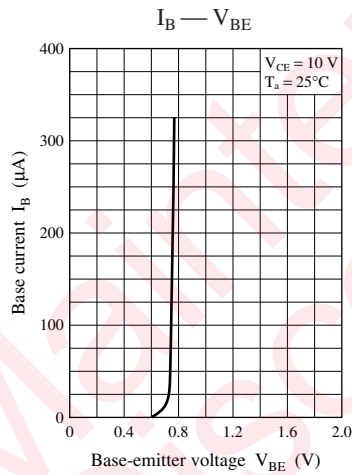
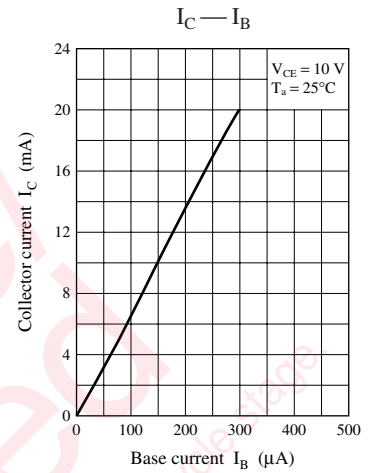
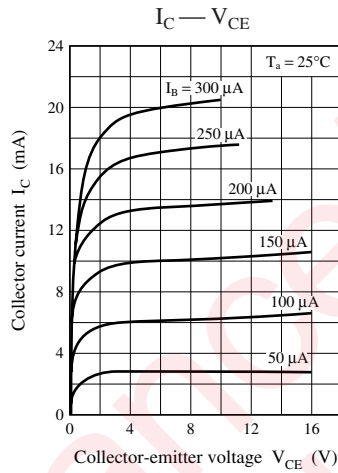
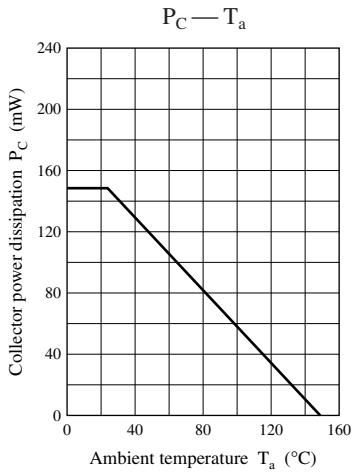
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	$I_C = 100 \mu\text{A}, I_E = 0$	30			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10 \mu\text{A}, I_C = 0$	3			V
Base-emitter voltage	$V_{BE}$	$V_{CB} = 10 \text{V}, I_E = -2 \text{mA}$		720		mV
Forward current transfer ratio	$h_{FE}$	$V_{CB} = 10 \text{V}, I_E = -2 \text{mA}$	25		250	—
Transition frequency *	$f_T$	$V_{CB} = 10 \text{V}, I_E = -15 \text{mA}, f = 200 \text{MHz}$	800		1600	MHz
Reverse transfer capacitance (Common base)	$C_{rb}$	$V_{CE} = 6 \text{V}, I_C = 0, f = 1 \text{MHz}$		0.8		pF
Reverse transfer capacitance (Common emitter)	$C_{re}$	$V_{CB} = 10 \text{V}, I_E = -1 \text{mA}, f = 10.7 \text{MHz}$		1.0	1.5	pF
Power gain	$G_P$	$V_{CB} = 10 \text{V}, I_E = -1 \text{mA}, f = 200 \text{MHz}$		20		dB

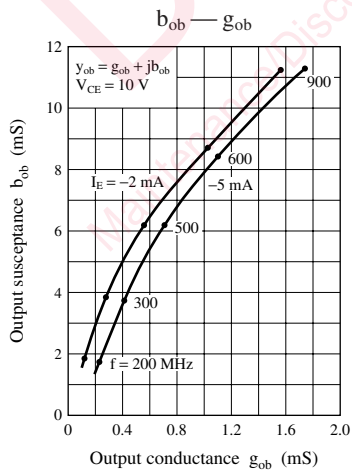
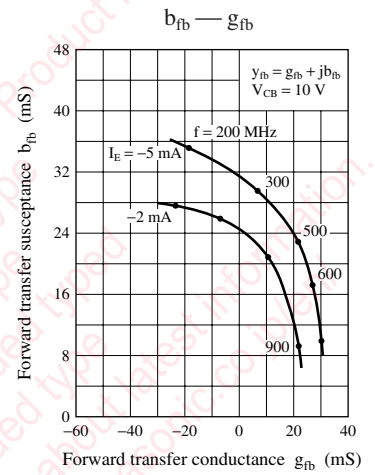
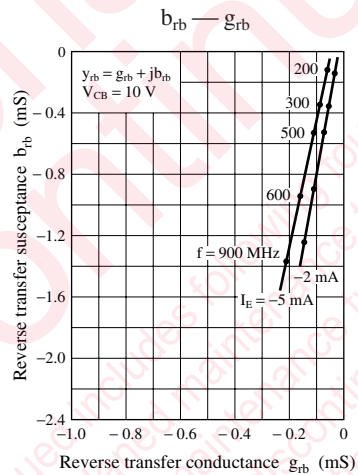
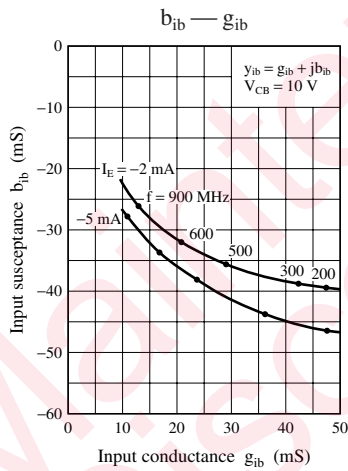
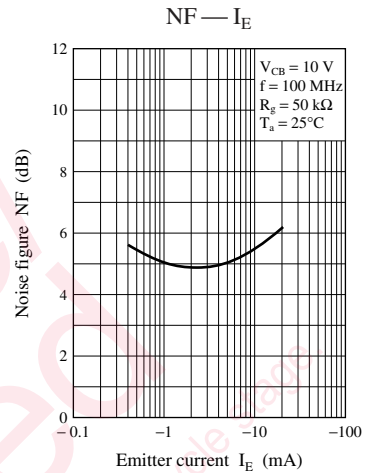
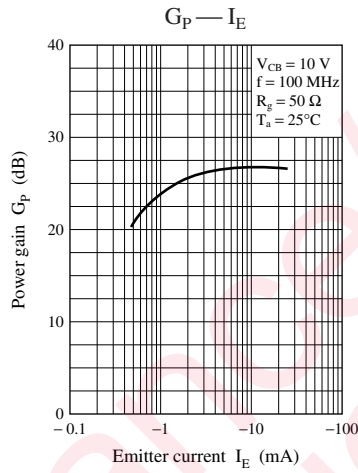
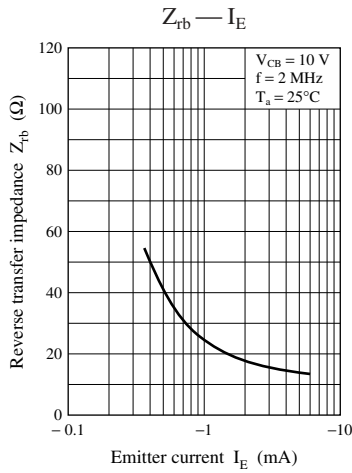
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Rank classification

Rank	T	S	No-rank
$f_T$	800 to 1400	1000 to 1600	800 to 1600
Marking symbol	RT	RS	R

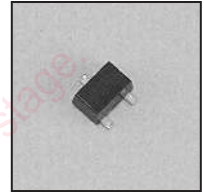
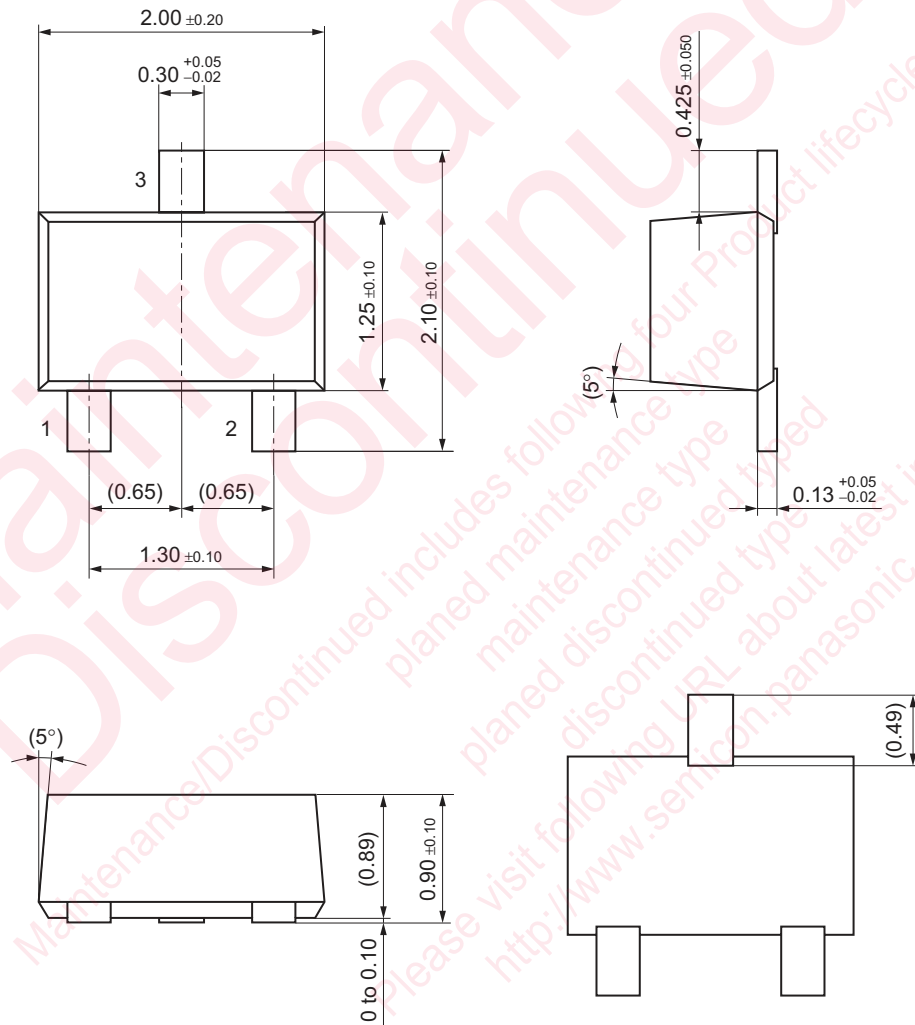
Product of no-rank is not classified and have no indication for rank.





SMini3-F2

Unit: mm



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